

Title (en)

METHOD AND APPLICATION DEVICE FOR APPLYING A STRIP-TYPE ADHESIVE AND COATING DEVICE FOR COATING SHEET-LIKE WORKPIECES

Title (de)

VERFAHREN UND APPLIZIEREINRICHTUNG ZUM APPLIZIEREN EINES BANDFÖRMIGEN HAFTMITTELS SOWIE BESCHICHTUNGSEINRICHTUNG ZUM BESCHICHTEN PLATTENFÖRMIGER WERKSTÜCKE

Title (fr)

PROCÉDÉ ET SYSTÈME D'APPLICATION DESTINÉ À APPLIQUER UN ADHÉSIF EN FORME DE BANDE AINSI QUE DISPOSITIF DE REVÊTEMENT POUR RECOUVRIR DES PIÈCES EN FORME DE PLAQUES

Publication

**EP 3969238 A1 20220323 (DE)**

Application

**EP 20726114 A 20200515**

Priority

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- EP 2020063628 W 20200515

Abstract (en)

[origin: WO2020234160A1] The invention relates to a method for applying a strip-type adhesive (11) on a narrow-surface coating material (12) by an application device (10), comprising the steps of: feeding the narrow-surface coating material (12) to a conveying device (15) of the application device (10) and transporting the narrow-surface coating material (12) to an energy source (17) and heating at least one surface (18) of the narrow-surface coating material (12) by the energy source (17), feeding the strip-type adhesive (11) and also the heated narrow-surface coating material (12) to a pressing-on device (21) and pressing the strip-type adhesive (11) onto the heated surface (18) and the narrow-surface coating material (12) by the pressing-on device (21), and also relates to an application device (10) for applying a strip-type adhesive (11) to a narrow-surface coating material (12) and relates to a coating device (24) for coating sheet-like workpieces (13).

IPC 8 full level

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CPC (source: EP)

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Citation (search report)

See references of WO 2020234160A1

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